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Electrical Characteristics (T _A = 25°C unless otherwise noted)								
Symbol	Parameter	Conditions	Min	Тур	Max	Units		
OFF CHA	RACTERISTICS							
I _{FL}	Forward Leakage Current	$V_{IN} = 8 V, V_{ONOFF} = 0 V$			1	μA		
I _{RL}	Reverse Leakage Current	$V_{IN} = -8 V, V_{ONOFF} = 0 V$			-1	μA		
ON CHAR	ACTERISTICS (Note 3)							
V _{IN}	Input Voltage		3		8	V		
V _{ON/OFF}	On/Off Voltage		1.5		8	V		
V _{DROP}	Conduction Voltage Drop @ 1A	$V_{IN} = 5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$		0.145	0.2	V		
		$V_{IN} = 3.3 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$		0.178	0.3			
I _L	Load Current	$V_{DROP} = 0.2 \text{ V}, V_{IN} = 5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			Α		
		$V_{DROP} = 0.3 \text{ V}, V_{IN} = 3.3 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			1		

Notes:

1. V_{IN} =8V, $V_{ON/OFF}$ =8V, V_{DROP} =0.5V, T_A =25°C

2. R_{pk} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{pk} is guaranteed by design while $\mathsf{R}_{_{\theta CA}}$ is determined by the user's board design.

 $P_{D}(t) = \frac{T_{J} - T_{A}}{R_{0,J,A}(t)} = \frac{T_{J} - T_{A}}{R_{0,J,C} R_{0,CA}(t)} = I_{D}^{2}(t) \times R_{DS(ON) \otimes T_{J}}$ Typical R_{ain} for single device operation using the board layouts shown below on FR-4 PCB in a still air environment:

a. 180°C/W when mounted on a 2oz minimum copper pad.



Scale 1 : 1 on letter size paper

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%



FDC6323L Rev.F





FDC6323L Rev.F

FDC6323L Load Switch Application





General Description

This device is particularly suited for compact computer peripheral switching applications where 8V input and 1A output current capability are needed. This load switch integrates a small N-Channel Power MOSFET (Q1) which drives a large P-Channel Power MOSFET (Q2) in one tiny SuperSOTTM-6 package.

A load switch is usually configured for high side switching so that the load can be isolated from the active power source. A P-Channel Power MOSFET, because it does not require its drive voltage above the input voltage, is usually more cost effective than using an N-Channel device in this particular application. A large P-Channel Power MOSFET minimizes voltage drop. By using a small N-Channel device the driving stage is simplified.

Component Values

R1	Typical	10k - 1MΩ	
R2	Typical	0 - 100kΩ	(optional)
C1	Typical	1000pF	(optional)

Design Notes

- R1 is needed to turn off Q2.
- R2 can be used to soft start the switch in case the output capacitance Co is small.
- R2 should be at least 10 times smaller than R1 to guarantee Q1 turns on.
- By using R1 and R2 a certain amount of current is lost from the input. This bias current loss is given by the equation

 $I_{BIAS_{LOSS}} = \frac{Vin}{R1 + R2}$ when the switch is ON. $I_{BIAS_{LOSS}}$ can be minimized by selecting a large

value for R1.

• R2 and C_{RSS} of Q2 make ramp for slow turn on. If excessive overshoot current occurs due to fast turn on, additional capacitance C1 can be added externally to slow down the turn on.

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